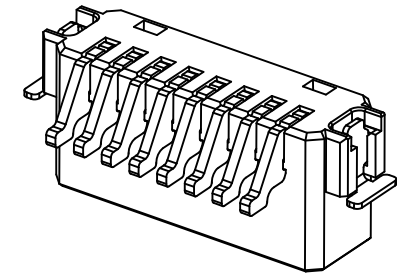


REV	ECN No.	DESCRIPTION	DESIGN	DATE
A0		Release	吴丹平	2016.05.13

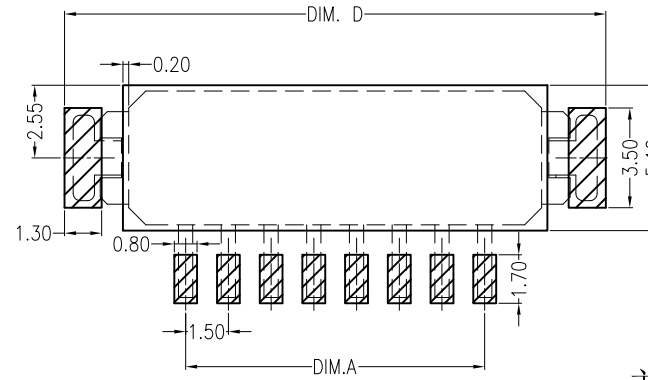
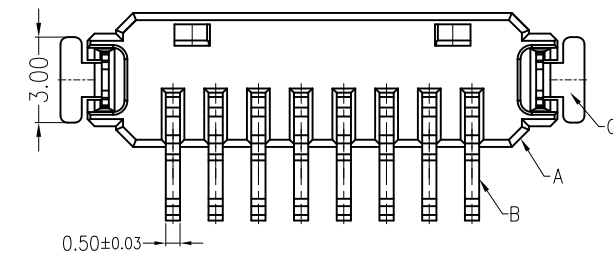


主要技术参数 Main Specifications

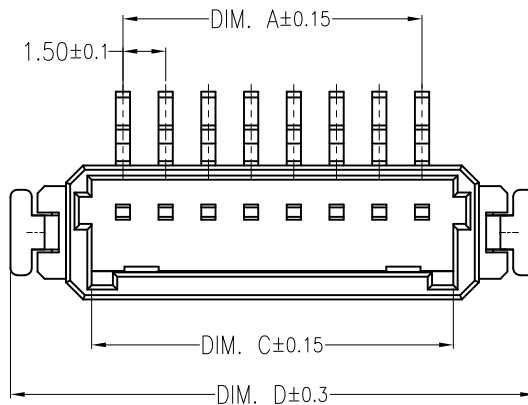
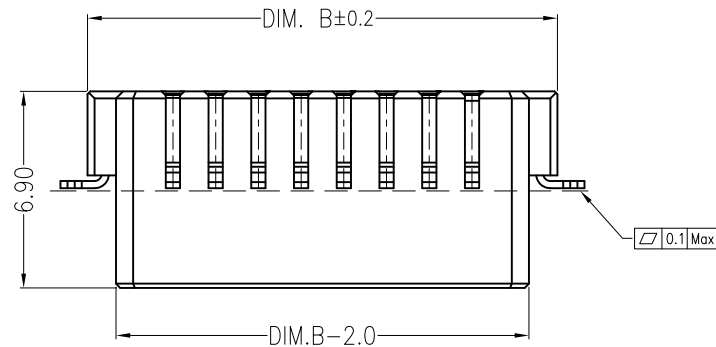
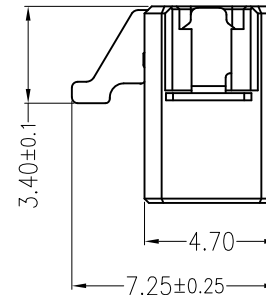
线 数 (Poles): 02 to 08
接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$
绝缘电阻 (Insulation resistance): $\geq 500\text{M}\Omega$
额定电压 (Rated voltage): 50V AC DC
额定电流 (Rated current): 1.5A AC DC
耐 电 压 (Withstand Voltage): 500V AC/minute
温度范围 (Temperature Range): $-40^\circ\text{C} \sim +120^\circ\text{C}$

ORDER INFORMATION:

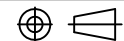
PART No. <u>L044AFV-**-F2MB-*</u>		PACKAGING:
No. FOR CIRCUITS: _____		R=REEL
**		P=PE
PLASTIC MATERIAL: _____		PLATING:
F2M=LCP (BEIGE)		B=MATTE Sn



Board Layout
General Tolerance: ± 0.05



Circuits	Dimensions (mm)			
	DIM. A	DIM. B	DIM. C	DIM. D
02	1.50	7.50	3.70	9.40
03	3.00	9.00	5.20	10.90
04	4.50	10.50	6.70	12.40
05	6.00	12.00	8.20	13.90
06	7.50	13.50	9.70	15.40
07	9.00	15.00	11.20	16.90
08	10.50	16.50	12.70	18.40

C	SOLDER TAB	2 PCS	Brass	MATTE Sn-plated
B	CONTACT	1~8 PCS	Brass	MATTE Sn-plated
A	HOUSING	1 PCS	LCP	UL 94V-0, COLOR: BEIGE
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
 东莞市高迪电子有限公司 DONG GUAN GAO DI ELECTRONICS CO., LTD				TITLE: 1.5Pitch 180°wafer smt type
X.±0.5	X.±5'	USE:	CUSTOMER	
.X±0.3	.X±2'	APPD:	邵敬和	
.XX±0.25	.XX±1'	CHKD:	田峰	
--	--	DR:	蒋建银	
		UNITS:	mm	
			SCALE 1 : 1	SHEET 1 / 1